



Mitsubishi Gas Chemical Company, Inc.

June 7, 2013

## **Completion of Buildings of the Overseas Subsidiary for Production of Electronic Materials and Construction of a Prototyping Laboratory in Japan**

Mitsubishi Gas Chemical Company, Inc. (MGC; Head Office: Chiyoda-ku, Tokyo; President: Kazuo Sakai) announces the completion of construction of MGC Electrotechno (Thailand) Co., Ltd., a subsidiary located in Hemaraj Eastern Seaboard Industrial Estate, Rayong Province, Thailand. A producer of electronic materials (copper clad laminates and prepregs), the new subsidiary will now go through the prototyping and customer approval process before starting commercial operation toward the end of 2013. The MGC electronic materials business will then have a total monthly production capacity of 1.25 million m<sup>2</sup>, including 1 million m<sup>2</sup> of the Shin-shirakawa Plant, MGC Electrotechno Co., Ltd., (ET; Location: Nishishirakawa-gun, Fukushima Pref.) and 0.25 million m<sup>2</sup> of the new subsidiary in Thailand.

The ET Shin-shirakawa Plant will start building a prototyping laboratory for copper clad laminates and prepregs. With the completion of the prototyping laboratory, the Shin-shirakawa site will enhance its functionality as the ET mother plant to meet the needs for faster product development, even higher performance, and more diversified products. The plant will introduce equipment for low- to medium-volume production of high-performance materials such as ultra-thin and low CTE materials.

In the globally expending market for semiconductors, MGC will quickly meet diversifying customer requirements and ensure a stable supply of high-performance products.

### **Overview of MGC Electrotechno (Thailand) Co., Ltd.**

1. Location: 500/128 Moo3, Tambol Tasit, Amphur Pluakdaeng, Rayong Province 21140, Thailand
2. Production capacity: 250,000 m<sup>2</sup> copper clad laminates per month
3. Start of commercial operation: End of 2013

### **Overview of Prototyping Laboratory at MGC Electrotechno Co., Ltd.**

1. Location: Shin-shirakawa Plant of MGC Electrotechno Co., Ltd. (Nishishirakawa-gun, Fukushima Pref.)
2. Building construction: Steel structure, partially two-storied
3. Building area: Approx. 2,500 m<sup>2</sup>, with a total floor area of approx. 3,500 m<sup>2</sup>
4. Equipment: Equipment for prototyping copper clad laminates and prepregs
5. Construction period: September 2013 to August 2014
6. Start of operation: October 2014

<Inquiries>

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